

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants : Hideyo Osanai et al. Confirmation No.:

Serial No. : 10/747,837

Filed: December 29, 2003

TC/A.U. Examiner

Docket No. : 03-745 Customer No. : 34704

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313

INFORMATION DISCLOSURE STATEMENT

Dear Sir:

In accordance with the requirements of 37 CFR 1.97 and 1.98, Applicants hereby submit the documents listed hereinbelow, which were cited in the European Search report, copies enclosed.

- (1) Patent Abstracts of Japan Publication No. 11000728
 entitled HEAT SINK AND METHOD FOR..., By Terada Atsushi,
 published January 6, 1999. The abstract is attached
 hereto.
- (2) U.S. Patent No. 4,788,765 entitled METHOD OF MAKING CIRCUIT ASSEMNLY WITH..., By Kaufman et al., patented December 6, 1988. The abstract is attached hereto.
- (3) U.S. Patent Application Publication No. 2002/0125563 entitled POWER SEMICONDUCTOR MODULE OF..., By
 Scheuermann, published September 12, 2002. The

abstract is attached hereto.

- (4) EP Patent No. 0 523 981 entitled METHOD OF MAKING
 ELECTRONIC PACKAGES AND..., By Prinz et al., published
 January 20, 1993. The abstract is attached hereto.
- (5) EP Patent No. 1 187 198 entitled METAL-CERAMIC CIRCUIT
 BOARD AND..., By Hideyo Osanai, published March 13, 2002.
 The abstract is attached hereto.
- (6) U.S. Patent No. 3,199,000 entitled MOUNT FOR SEMICONDUCTOR, By P. W. Nippert, patented August 3, 1965. The abstract is attached hereto.
- (7) U.S. Patent No. 5,526,867 entitled METHODS OF FORMING ELECTRONIC PACKAGES, By Keck et al., patented June 18, 1996. The abstract is attached hereto.

The undersigned submits the above-identified references for independent consideration by the Examiner and does not make any admission that these references are or are not material to the

present invention or that these references are or are not prior art with respect to the present invention.

Respectfully submitted,

Hideyo Osanai et al.

P. LaPointe

Attorney for Applicants

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Date: May 10, 2004

I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to: "Commissioner for Patants, P.O. Box 1450, Alexandria, VA 22313" on May 10, 2004.

Rachel Piscitelli

PTO/SB/08A (08-03)

Approved for use through 07/31/2006. OMB 0651-0031
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Substitute for April 10

Sheet 1

INFORMATION DISCLOSURE STATEMENT BY APPLICANT

(Use as many sheets as necessary)

of 1

Complete if Known			
Application Number	10/747,837		
Filing Date	December 29, 2003		
First Named Inventor	Hideyo Osanai et al.		
Art Unit			
Examiner Name			
Attorney Docket Number	03-745		

	1-27			DOCUMENTS	
Examiner nitials*	Cite No. ¹	Document Number Number-Kind Code ^{2 (f known)}	Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear
		^{us-} 2002/0125563 A1	09-12-2002	Scheuermann	
		^{US-} 3,199,000	08-03-1965	P. W. Nippert	
		^{US-} 5,526,867	06-18-1996	Keck et al.	
		^{US-} 4,788,765	12-06-1988	Kaufman et al.	
		US-			
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		US-			

Examiner Initials*	Cite No.1	Foreign Patent Document	Publication Date	Name of Patentee or Applicant of Cited Document	Pages, Columns, Lines, Where Relevant Passages	
- 4.		Country Code ³ "Number ⁴ "Kind Code ⁵ (if known)	MM-DD-YYYY		Or Relevant Figures Appear	T ⁶
		JP 11000728	01-06-1999	Terada Atsushi		
		EP 0 523 981	01-20-1993	Prinz et al.		
		EP 1 187 198	03-13-2002	Osanai		
		·				

Examiner	Date	
Signature	Considered	

*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant. ¹Applicant's unique citation designation number (optional). ²See Kinds Codes of USPTO Patent Documents at www.uspto.gov or MPEP 901.04. ³ Enter Office that issued the document, by the two-letter code (WIPO Standard ST.3). ⁴ For Japanese patent documents, the indication of the year of the reign of the Emperor must precede the serial number of the patent document. ⁵Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST.16 if possible. ⁶Applicant is to place a check mark here if English language Translation is attached.

This collection of information is required by 37 CFR 1.97 and 1.98. The information is required to obtain or retain a benefit by the public which is to file (and by the USPTO to process) an application. Confidentiality is governed by 35 U.S.C. 122 and 37 CFR 1.14. This collection is estimated to take 2 hours to complete, including gathering, preparing, and submitting the completed application form to the USPTO. Time will vary depending upon the individual case. Any comments on the amount of time you require to complete this form and/or suggestions for reducing this burden, should be sent to the Chief Information Officer, U.S. Patent and Trademark Office, P.O. Box 1450, Alexandria, VA 22313-1450. DO NOT SEND FEES OR COMPLETED FORMS TO THIS ADDRESS. SEND TO: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

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